

N-Channel 60 V (D-S) MOSFET

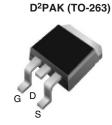
PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^{a, e}	Q _g (Max)		
60	0.023 at V _{GS} = 10 V	50	66 nC		
00	0.027 at V _{GS} = 4.5 V	40	00110		

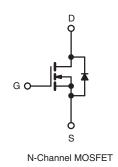
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Surface Mount
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Logic-Level Gate Drive
- Fast Switching
- Compliant to RoHS Directive 2002/95/EC









ABSOLUTE MAXIMUM RATINGS (To	_c = 25 °C, un	less otherwis	se noted)			
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage			V _{DS}	60	V	
Gate-Source Voltage	V _{GS}	± 10	v			
Continuous Drain Current ^f	V _{GS} at 10 V	T _C = 25 °C		50		
Continuous Drain Current	V _{GS} at 10 V	T _C = 100 °C	I _D	36	A	
Pulsed Drain Current ^a			I _{DM}	200	7	
Linear Derating Factor				1.0	W/°C	
Linear Derating Factor (PCB Mount) ^e	-	0.025	- W/ C			
Single Pulse Avalanche Energy ^b			E _{AS}	400	mJ	
Maximum Power Dissipation	pation $T_{\rm C} = 25 ^{\circ}{\rm C}$		Р	150	w	
Maximum Power Dissipation (PCB Mount) ^e	T _A = 25 °C		P _D	3.7		
Peak Diode Recovery dV/dt ^c			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	- °C	
Soldering Recommendations (Peak Temperature) ^d	for	10 s		300 ^d		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, $L = 179 \text{ }\mu\text{H}$, $R_g = 25 \Omega$, $I_{AS} = 51 \text{ A}$ (see fig. 12). c. $I_{SD} \le 51 \text{ A}$, dl/dt $\le 250 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 175 \text{ °C}$.

e. When mounted on 1" square PCB (FR-4 or G-10 material).

f. Current limited by the package, (die current = 51 A).

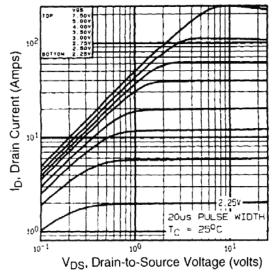
d. 1.6 mm from case.



THERMAL RESISTANCE RATI						T			
PARAMETER	SYMBOL	TYP. MAX.			UNIT				
Maximum Junction-to-Ambient	R _{thJA}	- 62			°C/W				
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	- 40							
Maximum Junction-to-Case (Drain)	R _{thJC}	- 1.0							
l ote . When mounted on 1" square PCB (FR-4 (or G-10 material).							
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	nless otherw	rise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNI		
Static		•				•		•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0, I _D = 250 μA		60	-	-	V		
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	0.070	-	V/°C		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		1.0	-	3.0	V		
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 10 \text{ V}$		-	-	± 100	nA		
-		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	25	μA		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 48 V, V _{GS} = 0 V, T _J = 150 °C		-	-	250			
Drain-Source On-State Resistance	_	V _{GS} = 10 V	۱ _D	= 21 A ^b	-	23	-	Ω	
	R _{DS(on)}	V _{GS} = 4.5 V		= 15 A ^b	-	27	-		
Forward Transconductance	g _{fs}	$V_{DS} = 25 \text{ V}, \text{ I}_{D} = 21 \text{ A}^{\text{b}}$		23	-	-	S		
Dynamic	010				1		1		
Input Capacitance	C _{iss}				-	3000	-		
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1.0 MHz, see fig. 5		-	1000	-	pF		
Reverse Transfer Capacitance	C _{rss}			-	200	-			
Total Gate Charge	Qg				-	60	-		
Gate-Source Charge	Q _{gs}	$V_{GS} = 5.0 V$ $I_D = 51 A, V_{DS} = 48 V,$			-	10	-	nC	
Gate-Drain Charge	Q _{gd}		see ng	g. 6 and 13 ^b	-	40	-		
Turn-On Delay Time	t _{d(on)}				-	17	-		
Rise Time	t _r			-	230	_	•		
Turn-Off Delay Time	t _{d(off)}			, see fig. 10 ^b	-	42	-	ns	
Fall Time	t _f				-	110	-		
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH		
Internal Source Inductance	Ls			-	7.5	-			
Drain-Source Body Diode Characteristic	s								
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	50°	A		
Pulsed Diode Forward Current ^a	I _{SM}			-	-	200			
Body Diode Voltage	V _{SD}	$T_J = 25 \ ^{\circ}C, \ I_S = 51 \ A, \ V_{GS} = 0 \ V^b$		-	-	2.5	V		
Body Diode Reverse Recovery Time	t _{rr}	$T_{\rm J} = 25 ^{\circ}\text{C}, I_{\rm F} = 51 \text{A}, \text{dl/dt} = 100 \text{A/}\mu\text{s}^{\rm b}$		-	130	180	ns		
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.84	1.3	μC		
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time i	s negligible (turn	-on is dor	ninated b	v Ls and	L _D)	

Notes
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. Pulse width ≤ 300 μs; duty cycle ≤ 2 %.
c. Current limited by the package, (Die Current = 51 A).





TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



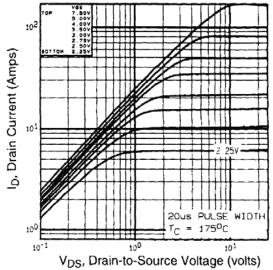
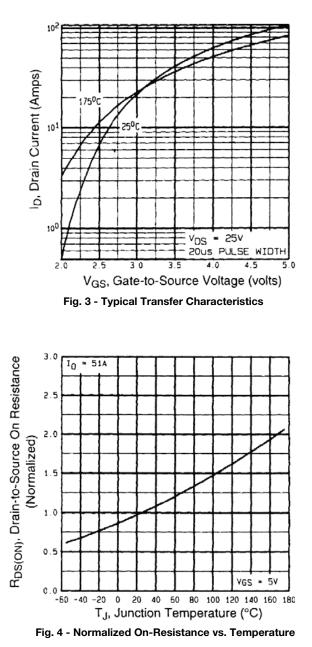


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C





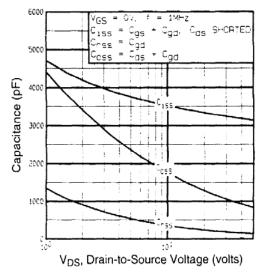


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

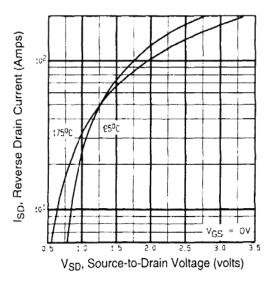


Fig. 7 - Typical Source-Drain Diode Forward Voltage

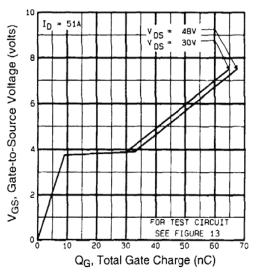
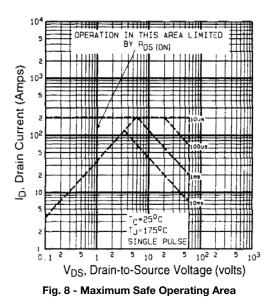


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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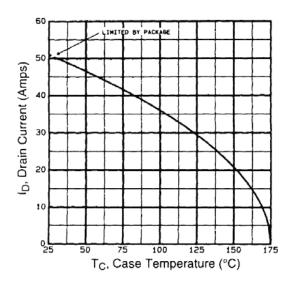


Fig. 9 - Maximum Drain Current vs. Case Temperature

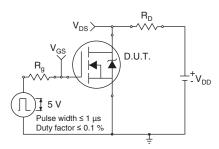


Fig. 10a - Switching Time Test Circuit

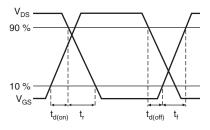
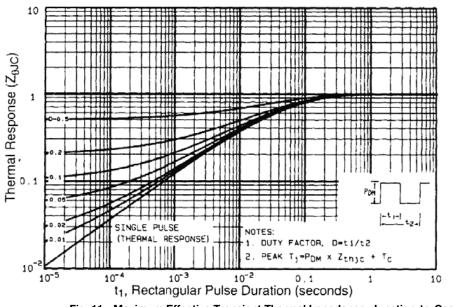


Fig. 10b - Switching Time Waveforms





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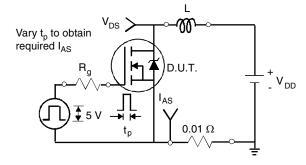


Fig. 12a - Unclamped Inductive Test Circuit

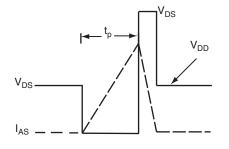


Fig. 12b - Unclamped Inductive Waveforms



Fig. 12c - Maximum Avalanche Energy vs. Drain Current

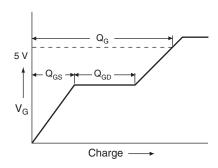


Fig. 13a - Basic Gate Charge Waveform

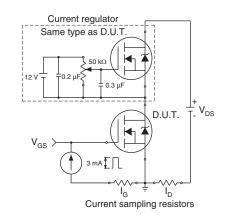
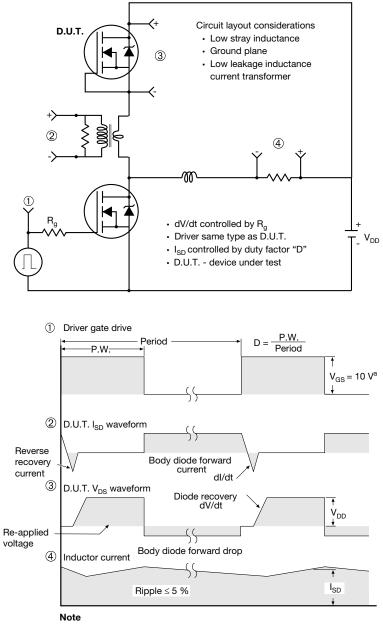


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit

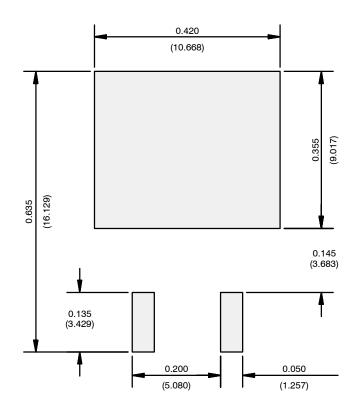


a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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